ST1116B

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Variable Speed Double Coil DC Brushless Motor Driver

This product is protected by the following patents:

China PAT.NO: ZL99207658.7

Other Patents are pending now, including USA 09/307,906, Taiwan 88202931, et al.





ST1116B

Variable Speed Double Coil

DC Brushless Motor Driver

General Specifications

The device is a driver with variable speed control for two-phase unipolar driver of DC brushless fan motor applications. The device is intended to be used as an interface between a HALL effect latch and a double coil load. The device has functions such as driving, rotation detecting, lock protection, self-restart and speed control.

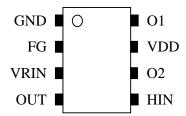
An open-drain FG pin outputs the pulses, of which the frequency is proportional to the fan speed. With suitable output pull up, this fan tachometer output can be used directly with bipolar or MOS logic for motor speed monitoring/control.

Features and Benefits

- Variable fan speed control
- Motor starts at low speed
- Lock protection and automatic self-restart
- Tachometer output
- High output sinking current capability
- Connectable direct to a HALL Latch IC
- Thin, highly reliable package (SOP-8)



Pin Assignment



Pin NO.	Pin Name	Description
1	GND	Ground
2	FG	Fan tachometer output (open-drain)
3	VRIN	Input pin for variable speed control function
4	OUT	Output pin to control the external source driver
5	HIN	Input pin from Hall Latch IC
6	O2	Output sinking driver 2
7	VDD	Power supply
8	01	Output sinking driver 1

Absolute Maximum Ratings ($T_A=25^{\circ}C$)

Characteristic	Symbol	Rating	Unit
Supply Voltage	V_{DD}	14	V
Input Voltage	V _{IN}	V _{DD} +0.4	V
Output Current at Lock	I _{OUT}	600	mA
Output Current at Operating	I _{OPR}	300	mA
Power Dissipation	P_D	0.44	W
Operating Temperature Range	T _A	-40 ~ 125	°C
Storage Temperature Range	Ts	-65 ~ 150	°C
Operating Junction Temperature	TJ	125	°C
Thermal Resistance, Junction to Ambient	θ_{JA}	156.5	°C/W
Thermal Resistance, Junction to Case	θ_{JC}	42	°C/W



Electrical Characteristic ($T_A = 25^{\circ}C$ & $V_{DD} = 12 V$)

Characteristic	Sym.	Condition	Limit			Unit		
Characteristic			Min.	Тур.	Max.	Offic		
Supply Voltage	V_{DD}	Operating	3	12	14	V		
Quiescent Current	I _{DD}	No load, All Inputs = $0V$ or V_{DD}	-	4.5	-	mA		
HIN Input Terminal	HIN Input Terminal							
Input Voltage "H"	V _{IH}	-	0.8*V _{DD}	-	V _{DD} +0.4	V		
Input Voltage "L"	V_{IL}	-	-0.4	-	0.2*V _{DD}	V		
Input Current "H"	I _{IH}	$V_{IN} = V_{DD}$	-	-	4	μ A		
O1 / O2 Output Terminal (T _J = 25℃)								
Output Voltage Low	V _{OL}	I _{OUT} = 250mA	-	0.3	-	V		
FG Open-Drain Terminal (T _J = 25°ℂ)								
Output Leakage Current	I _{Leak}	V _{FG} =12V		-	10	μ A		
Output Current	I _{FG}	V _{FG} = 0.4V	-	10	-	mA		
Output Voltage High	V_{FGOH}	-	-	-	15	V		
Automatic Self-Restart Circuit								
On Time	T _{ON}		-	160	-	ms		
Duty Ratio	R _{DR}	T _{OFF} / T _{ON}	6	7	8			
OUT Terminal								
OUT Voltage High	V_{OUTH}	VRIN =3.81V	-	11.9	-	V		
OUT Voltage Low	V_{OUTL}	VRIN =4.89V	-	3.2	-	V		

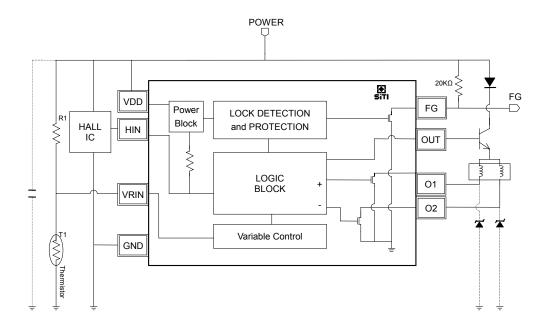


Truth Table

• Drivers Output

HIN	01	O2	
Н	OFF	ON	
L	ON	OFF	

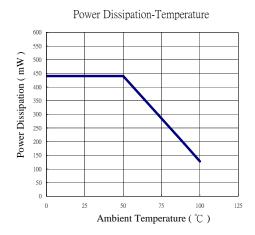
Block Diagram & Application Circuit





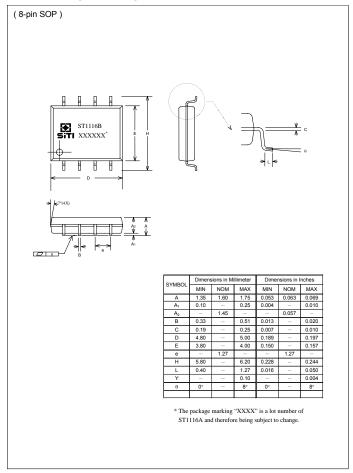
Application Notes

- The FG pin is an open-drain output. A resistor can be used to pull up the FG voltage to the appropriate level, which depends on the voltage level of the monitoring/control system. Without the additional pull-up resistor, the FG voltage will be V_{DD} when the fan stops.
- The power dissipated by the IC varies widely with the supply voltage, the output current, and loading. It is important to ensure the application does not exceed the allowable power dissipation of the IC package. The recommended *motor driver* power dissipation versus temperature is depicted as follows:





Package Specifications (SOP-8)



The products listed herein are designed for ordinary electronic applications, such as electrical appliances, audio-visual equipment, communications devices and so on. Hence, it is advisable that the devices should not be used in medical instruments, surgical implants, aerospace machinery, nuclear power control systems, disaster/crime-prevention equipment and the like. Misusing those products may directly or indirectly endanger human life, or cause injury and property loss.

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